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Microwave Processing Technology for a Variety of Materials

Guest Editor:

Prof. Dr. Dinesh Agrawal

Engineering Science and Mechanics, Pennsylvania State University, University Park, TX, USA

Deadline for manuscript submissions: closed (28 February 2022)

Message from the Guest Editor

Dear Colleagues,

The application of microwave energy in material processing is now widely used for a variety of materials including ceramics, metals, polymers, composites, biomaterials, etc. However, success in the laboratory has not been, in many cases, translated to the marketplace. Recent new areas of microwave energy applications include powder metals, steel making, the sintering of 3D-printed objects, and used-tire recycling. However, the commercialization of microwave technology in these areas has not yet been successful. This Special Issue will accept original manuscripts on microwave energy applications to these and related fields. Special attention will be paid to manuscripts involving innovative techniques leading to their commercialization.

With immense pleasure, we invite you to submit a manuscript for this Special Issue. Full papers, communications and reviews are welcome.









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Editor-in-Chief

Prof. Dr. Maryam Tabrizian

 Department of Biomedical Engineering, Faculty of Medicine and Health Sciences, McGill University, Montreal, QC H3A 2B6, Canada
Faculty of Dentistry and Oral Health Sciences, McGill University, 3640 Rue University, Montreal, QC H3A 0C7, Canada

Message from the Editor-in-Chief

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Materials Editorial Office MDPI, St. Alban-Anlage 66 4052 Basel, Switzerland Tel: +41 61 683 77 34 www.mdpi.com mdpi.com/journal/materials materials@mdpi.com X@Materials_Mdpi